

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Chung-Chuan Hsieh	04/06/2010
RECEIVING PARTY DATA	
Name:	Everlight Electronics Co., Ltd.
Street Address:	No. 25, Lane 76, Sec. 3, Chung Yang Rd.
City:	Tucheng City, Taipei County
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29359194
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NAME OF SUBMITTER:	Daniel R. McClure
Total Attachments: 2 source=01126014#page1.tif source=01126014#page2.tif	

OP \$40.00 29359194

ASSIGNMENT

WHEREAS, I, Chung-Chuan HSIEH, residing at No. 25, Lane 76, Sec.3, Chung Yang Rd., Tucheng City, Taipei County, Taiwan, R.O.C., has invented certain new and useful improvements in LIGHT EMITTING DIODE, for which an application for Letters Patent of the United States is being made, said application having been executed on even date herewith, and which may be identified in the United States Patent Office by Application No. _____, filed _____.

WHEREAS, EVERLIGHT ELECTRONICS CO., LTD., ("Assignee"), a business entity organized and existing under the laws of the Taiwan, R.O.C., and having its principal offices at No. 25, Lane 76, Sec.3, Chung Yang Rd., Tucheng City, Taipei County, Taiwan, R.O.C., is desirous of acquiring the entire right, title and interest in and to said invention, said application and in, to and under any and all Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of good and valuable consideration to us in hand paid by said Assignee, the receipt of which is hereby acknowledged, I has sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto the said Assignee, its successors and assigns, our entire right, title and interest in and to said invention, said provisional/utility application, all applications claiming priority to said provisional/utility application including all divisions, continuations or renewals thereof, and the Letters Patent, that may or shall issue, therefrom including all reissues or extensions of such patents, and I does hereby authorize and request the Commissioner of Patents to issue said Letters Patent to the above mentioned Assignee in accordance herewith.

I hereby authorize the above mentioned Assignee, its successors and assigns, or anyone it may properly designate, to insert in this instrument the date of execution and/or filing date and application number of said application when ascertained. I further authorize said Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent, in its own name if desired.

Upon said consideration I does hereby covenant and agree with the said Assignee, its successors and assigns, that I will not execute in writing or do any act whatsoever conflicting with these presents, and that I or the executors or administrators will at any time upon request, without further or additional consideration, but at the expense of the said Assignee, its successors and assigns, execute such additional writings and do such additional acts as said Assignee, its successors and assigns, may deem necessary or desirable to perfect the Assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, on said invention, and in enforcing any rights occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

IN WITNESS WHEREOF, I has hereunto set our hands and affixed our seal as dated below.

Date: 2010.4.6

chung chuan HSIEH
Chung-Chuan HSIEH